

NLAS3257

Mux / Demux Analog Switch

The NLAS3257 Mux / Demux Analog Switch is an advanced high-speed single pole double throw (SPDT) analog switch in ultra-small footprint.

Features

- High Speed: $t_{PD} = 0.25 \text{ ns (Max) @ } V_{CC} = 4.5 \text{ V}$
- R_{ON} : 7.5Ω , Typ @ $V_{CC} = 4.2 \text{ V}$
- C_{ON} : 7.5 pF , Typ @ $V_{CC} = 3.3 \text{ V}$
- V_{CC} Range: $1.65 \text{ V to } 4.5 \text{ V}$
- Ultra-Small $1 \times 1 \text{ mm}$ Package
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Mobile Phones, PDAs, Camera

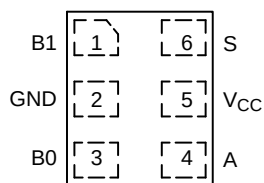


Figure 1. XLLGA6
(Top View)

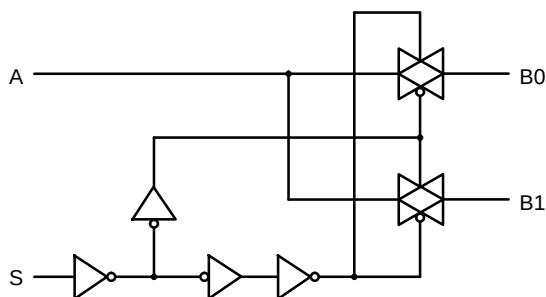


Figure 2. Logic Diagram

Function Table

Input S	Function
L	A = B0
H	A = B1



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MARKING DIAGRAM



XLLGA6
1.0 x 1.0
CASE 713AD



L = Specific Device Code
M = Date Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

Table 1. MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage	-0.5 to +5.5	V
V_{IN}	Control Input Voltage (S Pin)	-0.5 to +5.5	V
$V_{I/O}$	Switch Input / Output Voltage (A, B0, B1 Pins)	-0.5 to +5.5	V
I_{IK}	Control Pin DC Input Diode Current (S Pin) $V_{IN} < GND$	-50	mA
I_{OK}	Switch I/O Port DC Diode Current (A, B0, B1 Pins) $V_{I/O} < GND$ or $V_{I/O} > V_{CC}$	± 50	mA
I_O	On-State Switch Current	± 128	mA
	Continuous Current Through V_{CC} or GND	± 150	mA
I_{CC}	DC Supply Current per Supply Pin	± 150	mA
I_{GND}	DC Ground Current per Ground Pin	± 150	mA
T_{STG}	Storage Temperature Range	-65 to +150	°C
T_L	Lead Temperature, 1 mm from Case for 10 Seconds	260	°C
T_J	Junction Temperature Under Bias	150	°C
θ_{JA}	Thermal Resistance (Note 1) XLLGA6	466	°C/W
P_D	Power Dissipation in Still Air at 85°C (Note 1) XLLGA6	269	mW
MSL	Moisture Sensitivity	Level 1	
F_R	Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	
V_{ESD}	ESD Withstand Voltage Human Body Mode (Note 2)	>6000	V
	Machine Mode (Note 3)	>200	
	Charged Device Mode (Note 4)	N/A	
$I_{LATCHUP}$	Latchup Performance Above V_{CC} and Below GND at 85°C (Note 5)	± 100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow.
2. Tested to EIA/ JESD22-A114-A
3. Tested to EIA/ JESD22-A115-A
4. Tested to JESD22-C101-A
5. Tested to EIA / JESD78.

Table 2. RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{CC}	Positive DC Supply Voltage	1.65	4.5	V
V_I	Control Pin Input Voltage (S Pin)	0	4.5	V
$V_{I/O}$	Switch Input / Output Voltage (A, B0, B1 Pins)	0	V_{CC}	V
T_A	Operating Free-Air Temperature	-40	+85	°C
$\Delta t / \Delta V$	Input Transition Rise or Fall Rate Control Input Switch I/O	0 0	20 DC	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Table 3. DC ELECTRICAL CHARACTERISTICS (Typical: T = 25°C, V_{CC} = 3.3 V)

Symbol	Parameter	Test Conditions	V _{CC} (V)	T _A = -40°C to +85°C			Unit
				Min	Typ	Max	
V _{IH}	Control Input, High Voltage (S Pin)		2.7 3.3 4.2	0.8 1.0 1.25			V
V _{IL}	Control Input, Low Voltage (S Pin)		2.7 3.3 4.2			0.3 0.4 0.5	V
I _{IN}	Control Input, Leakage Current (S Pin)	0 ≤ V _{IN} ≤ V _{CC}	1.65 – 4.5		±0.5	±1.0	μA
I _{B0/B1_OFF}	Off State Leakage Current (B0/B1 Pins)	V _{IN} = V _{IL} or V _{IH} V _{B0} and V _{B1} = 0.3 V V _A = 4 V	4.5		±20	±100	nA
I _{A_ON}	On State Leakage Current (A Pin)	V _{IN} = V _{IL} or V _{IH} V _{B0} = 0.3 V or 4 V with V _{B1} = Floating or V _{B1} = 0.3 V or 4 V with V _{B0} = Floating V _A = 0.3 V or 4.0 V	4.5		±20	±100	nA
I _{Power_OFF}	Power Off Leakage Current (S Pin)	V _{IN} = 0 or 4.5 V	0			±100	nA
I _{CC}	Quiescent Supply Current (V _{CC} Pin)	V _{IN} = V _{CC} or GND, V _{IS} = V _{CC} or GND, I _{Load} = 0 A	1.65 – 4.5		0.1	1.0	μA
ΔI _{CC}	Additional Quiescent Supply Current (V _{CC} Pin)	V _{IN} = V _{CC} or GND, V _{IS} = V _{CC} or GND, I _{Load} = 0 A	3.3 4.2			2.0 3.0	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Table 4. ON RESISTANCE (Typical: T = 25°C)

Symbol	Parameter	Test Conditions	V _{CC} (V)	T _A = -40°C to +85°C			Unit
				Min	Typ	Max	
R _{ON}	ON-Resistance	I _{ON} = 8 mA, V _{IS} = 0 V to V _{CC}	2.7 3.3 4.2		9.3 8.7 7.5		Ω
R _{FLAT}	ON-Resistance Flatness	I _{ON} = 8 mA, V _{IS} = 0 V to V _{CC}	2.7 3.3 4.2		3.6 3.3 2.9		Ω
ΔR _{ON}	Delta ON- Resistance	I _{ON} = 8 mA, V _{IS} = 0 V to V _{CC}	2.7 3.3 4.2		0.8 0.7 0.5		Ω

AC ELECTRICAL CHARACTERISTICS

Table 5. TIMING/FREQUENCY (Typical: T = 25°C, V_{CC} = 3.3 V, R_L = 50 Ω, C_L = 5 pF, f = 1 MHz)

Symbol	Parameter	Test Condition	V _{CC} (V)	T _A = -40°C to +85°C			Unit
				Min	Typ	Max	
t _{PD}	Propagation Delay, A to Bn or Bn to A		1.65 – 4.5			0.25	ns
t _{ON}	Turn-ON Time	(See Figures 4 and 5)	1.65 – 4.5		12	30	ns
t _{OFF}	Turn-OFF Time	(See Figures 4 and 5)	1.65 – 4.5		8.0	25	ns
t _{BBM}	Break-Before-Make Time	(See Figure 3)	1.65 – 4.5	2.0			ns
BW	-3 dB Bandwidth	C _L = 5 pF	1.65 – 4.5		900		MHz

Table 6. ISOLATION (Typical: T = 25°C, V_{CC} = 3.3 V, R_L = 50 Ω, C_L = 5 pF)

Symbol	Parameter	Test Condition	V _{CC} (V)	T _A = -40°C to +85°C			Unit
				Min	Typ	Max	
O _{IRR}	OFF-Isolation	f = 240 MHz (See Figure 6)	1.65 – 4.5		-21		dB
X _{TALK}	Non-Adjacent Channel Crosstalk	f = 240 MHz	1.65 – 4.5		-21		dB

Table 7. CAPACITANCE (Typical: T = 25°C, V_{CC} = 3.3 V, f = 1 MHz)

Symbol	Parameter	Test Condition	T _A = -40°C to +85°C			Unit
			Min	Typ	Max	
C _{IN}	Control Input Capacitance	S pin			2.0	pF
C _{ON}	ON Capacitance	Switch ON A to B0 A to B1			7.5	pF
C _{OFF}	OFF Capacitance	Switch OFF B0 OFF B1 OFF			2.5	pF

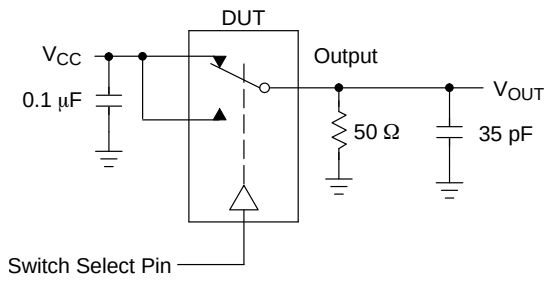
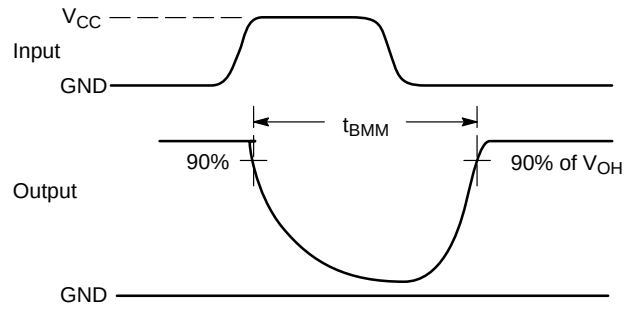


Figure 3. t_{BMM} (Time Break-Before-Make)

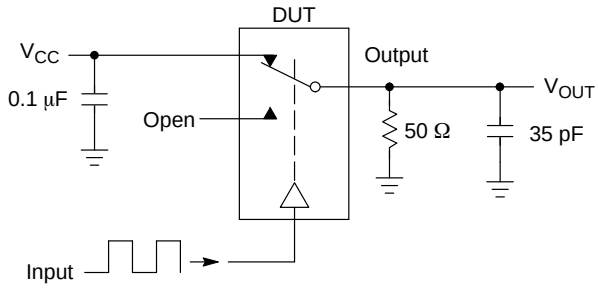
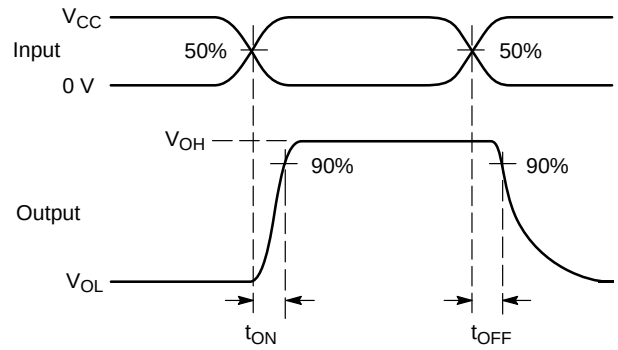


Figure 4. t_{ON}/t_{OFF}

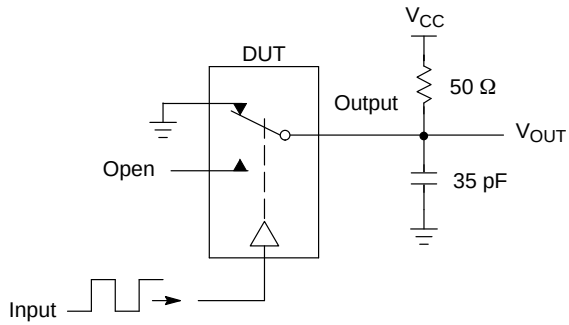
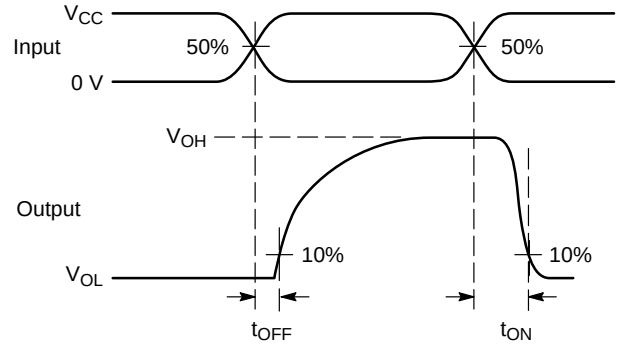
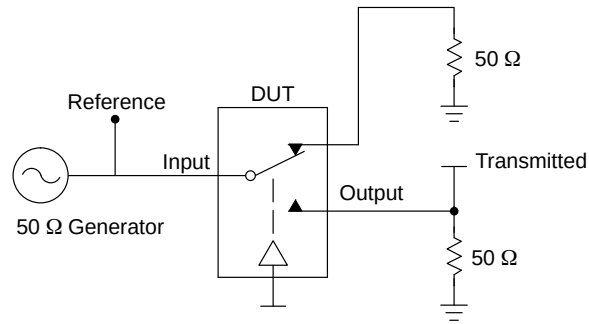


Figure 5. t_{ON}/t_{OFF}

NLAS3257



Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch. V_{ISO} , Bandwidth and V_{ONL} are independent of the input signal direction.

$$V_{ISO} = \text{Off Channel Isolation} = 20 \text{ Log} \left(\frac{V_{OUT}}{V_{IN}} \right) \text{ for } V_{IN} \text{ at } 100 \text{ kHz}$$

$$V_{ONL} = \text{On Channel Loss} = 20 \text{ Log} \left(\frac{V_{OUT}}{V_{IN}} \right) \text{ for } V_{IN} \text{ at } 100 \text{ kHz to } 50 \text{ MHz}$$

Bandwidth (BW) = the frequency 3 dB below V_{ONL}

V_{CT} = Use V_{ISO} setup and test to all other switch analog input/outputs terminated with 50 Ω

**Figure 6. Off Channel Isolation/On Channel Loss (BW)/Crosstalk
(On Channel to Off Channel)/ V_{ONL}**

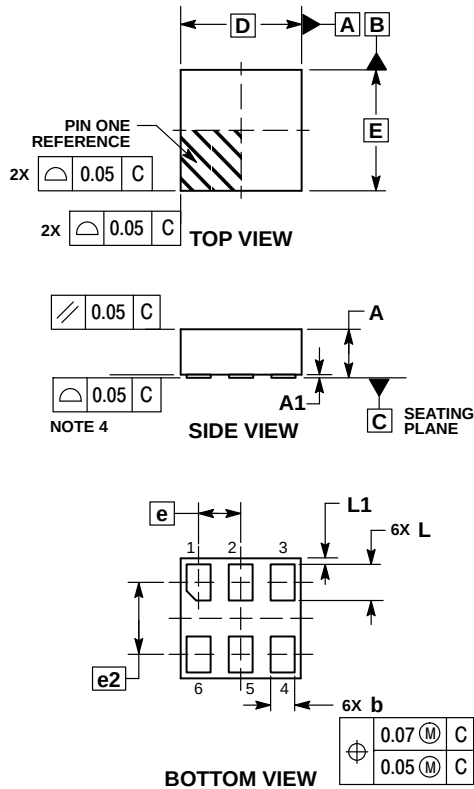
DEVICE ORDERING INFORMATION

Device	Package	Shipping [†]
NLAS3257CMX2TCG	XLLGA6 – 1.0 x 1.0, 0.35P (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

XLLGA6 1.0x1.0, 0.35P
CASE 713AD
ISSUE O

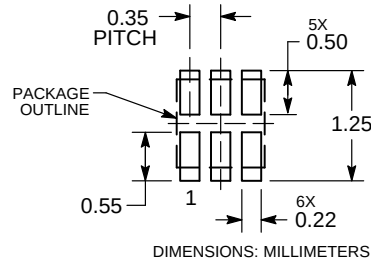


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO THE PLATED TERMINALS AND IS MEASURED BETWEEN 0.15 AND 0.25 MM FROM THE TERMINAL TIPS.
4. COPLANARITY APPLIES TO ALL OF THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	---	0.40
A1	0.00	0.05
b	0.17	0.23
D	1.00 BSC	
E	1.00 BSC	
e	0.35 BSC	
e2	0.60 BSC	
L	0.27	0.33
L1	0.05 REF	

RECOMMENDED
SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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